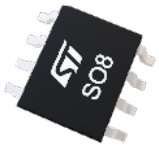
TSB622

Datasheet

Low power, 1.7 MHz, rail-to-rail output, 36 V operational amplifier

MiniSO8



SO8

DFN8 (3 x 3 mm)
Wettable flanks

Maturity status link
TSB622

Related products	
TSB612	For lower speed
TSB572	For higher speed and rail-to-rail inputs
TSB712	For a higher precision and speed

Features

- Low offset voltage: 1 mV max. @ 25 °C
- Low current consumption: 375 µA max. / operator @ 36 V
- Wide supply voltage: 2.7 to 36 V
- Gain bandwidth product: 1.7 MHz
- Unity gain stable
- Rail-to-rail output
- Input common mode voltage incudes ground
- High ESD tolerance: 4 kV HBM
- EMI hardened
- Extended temperature range: -40 to 125 °C
- Automotive qualification
- Micropackage: SO8, MiniSO8, DFN8 3x3 Wettable flanks

Applications

- Industrial
- Power supplies
- Automotive

Description

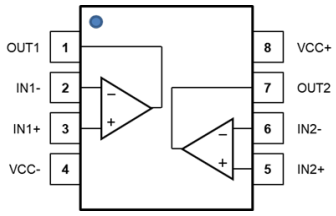
The TSB622 is a general purpose dual operational amplifier featuring an extended supply voltage operating range and rail-to-rail output. It also offers an excellent speed/power consumption ratio with 1.7 MHz gain bandwidth product while consuming less than 375 µA per operator at 36 V supply voltage.

The TSB622 operates over a wide temperature range from -40 °C to 125 °C making this device ideal for industrial and automotive applications with the associated qualification.

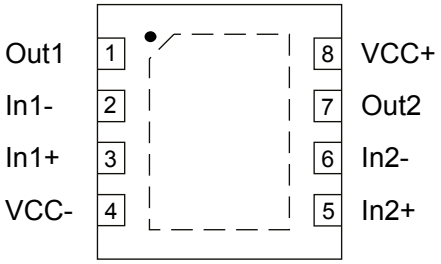
Thanks to its small package size, the TSB622 can be used in applications where space on the board is limited. It can thus reduce the overall cost of the PCB.

1 Pin connections

Figure 1. Pin connections (top view)



SO8 - MiniSO8



DFN8 (3 x 3) (1)

(1) Exposed pad can be left floating or connected to ground.

Table 1. Pin description

Pin n°	Pin name	Description
1	OUT1	Output
2	IN1 -	Negative input voltage
3	IN1 +	Positive input voltage
4	VCC -	Negative supply voltage
5	IN2 +	Positive input voltage
6	IN2 -	Negative input voltage
7	OUT2	Output
8	VCC +	Positive supply voltage

2 Absolute maximum ratings and operating conditions

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{cc}	Supply voltage (1)	40	V
V_{id}	Differential input voltage (2)	± V_{cc}	V
V_{in}	Input voltage	(V_{cc-}) -0.2 to (V_{cc+}) +0.2	V
I_{in}	Input current (3)	10	mA
T_{stg}	Storage temperature	-65 to 150	°C
T_j	Junction temperature	150	°C
R_{th-ja}	Thermal resistance junction to ambient (4) (5) SO8 MiniSO8 DFN8 3x3 WF	 125 190 40	°C/W
ESD	Human Body Model (HBM) (6)	4000	V
	Machine Model (MM) (7)	200	
	Charged Device Model (CDM) (8)	1500	

1. *All voltage values, except differential voltage, are with respect to network ground terminal.*
2. *The differential voltage is the non-inverting input terminal with respect to the inverting input terminal.*
3. *Input current must be limited by a resistor in series with the inputs.*
4. *R_{th} are typical values.*
5. *Short-circuits can cause excessive heating and destructive dissipation.*
6. *According to JEDEC standard JESD22-A114F.*
7. *According to JEDEC standard JESD22-A115A.*
8. *According to ANSI/ESD STM5.3.1.*

Table 3. Operating conditions

Symbol	Parameter	Value	Unit
V_{cc}	Supply voltage	2.7 to 36	V
V_{icm}	Common mode voltage on input pins	(V_{cc-}) -0.1 to (V_{cc+}) -1	V
T	Operating free-air temperature range	-40 to 125	°C

3 Electrical characteristics

Table 4. Electrical characteristics V_{CC+} = 2.7 V, V_{cc-} = 0 V, V_{icm} = V_{CC}/2, T = 25 °C, R_L = 10 kΩ connected to V_{CC}/2 (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
DC performance						
V_{IO}	Input offset voltage	T = 25 °C	-1		1	mV
		Tmin < T < Tmax	-1.6		1.6	
$\|\Delta V_{IO}/\Delta T\|$	Input offset voltage drift	Tmin < T < Tmax		2		µV/°C
I_{IB}	Input bias current	T = 25 °C		15	30	nA
		Tmin < T < Tmax			45	
I_{IO}	Input offset current	T = 25 °C		3	10	
		Tmin < T < Tmax			15	
CMR	Common mode rejection ratio: 20 log ($\Delta V_{icm}/\Delta V_{io}$)	V_{icm} = - 0.1 to V_{CC} -1 V, V_{OUT} = V_{CC}/2	90	115		dB
		Tmin < T < Tmax	85			
A_{VD}	Large signal voltage gain	V_{OUT} = 0.5 V to (V_{CC} -0.5 V)	90	105		dB
		Tmin < T < Tmax	82			
V_{OH}	High-level output voltage, V_{OH} = V_{CC} - V_{OUT}	T = 25 °C		35	46	mV
		Tmin < T < Tmax			55	
V_{OL}	Low-level output voltage	T = 25 °C		50	60	
		Tmin < T < Tmax			75	
I_{OUT}	I_{sink}	V_{OUT} = V_{CC}	20	27		mA
		Tmin < T < Tmax	10			
	I_{source}	V_{OUT} = 0 V	20	28		
		Tmin < T < Tmax	8			
I_{CC}	Supply current (per channel)	No load, V_{OUT} = V_{CC}/2		280	330	µA
		Tmin < T < Tmax			400	
AC performance						
GBP	Gain bandwidth product	R_L = 10 kΩ, C_L = 100 pF	1	1.45		MHz
		Tmin < T < Tmax	0.7			
Φ_m	Phase margin	R_L = 10 kΩ, C_L = 100 pF		60		degrees
G_m	Gain margin			18		dB
SR	Slew rate	T = 25 °C	0.30	0.53		V/µs
		Tmin < T < Tmax	0.20			
E_N	Equivalent input noise voltage	f = 1 kHz		30		nV/√Hz
THD+N	Total harmonic distortion + noise	f_{in} = 1 kHz, Gain = 1, R_L = 100 kΩ, V_{icm} = (V_{cc} -1 V) / 2, BW = 22 kHz, V_{OUT} = 1 Vpp		0.005		%
C_S	Channel separation	f = 1 kHz		120		dB
t_{rec}	Overload recovery time			2		µs

Table 5. Electrical characteristics V_{CC+} = 12 V, V_{CC-} = 0 V, V_{icm} = V_{CC}/2, T = 25 °C, R_L = 10 kΩ connected to V_{CC}/2 (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
DC performance						
V_{IO}	Input offset voltage	T = 25 °C	-1		1	mV
		Tmin < T < Tmax	-1.6		1.6	
$\|\Delta V_{IO}/\Delta T\|$	Input offset voltage drift	Tmin < T < Tmax		2		µV/°C
I_{IB}	Input bias current	T = 25 °C		15	30	nA
		Tmin < T < Tmax			45	
I_{IO}	Input offset current	T = 25 °C		3	10	
		Tmin < T < Tmax			15	
CMR	Common mode rejection ratio: 20 log ($\Delta V_{icm}/\Delta V_{io}$)	V_{icm} = - 0.1 to V_{CC} -1 V, V_{OUT} = V_{CC}/2	100	130		dB
		Tmin < T < Tmax	95			
A_{VD}	Large signal voltage gain	V_{OUT} = 0.5 V to (V_{CC} -0.5 V)	98	115		dB
		Tmin < T < Tmax	90			
V_{OH}	High-level output voltage, V_{OH} = V_{CC} - V_{OUT}	T = 25 °C		68	80	mV
		Tmin < T < Tmax			95	
V_{OL}	Low-level output voltage	T = 25 °C		86	100	
		Tmin < T < Tmax			125	
I_{OUT}	I_{sink}	V_{OUT} = V_{CC}	25	35		mA
		Tmin < T < Tmax	10			
	I_{source}	V_{OUT} = 0 V	30	37		
		Tmin < T < Tmax	15			
I_{CC}	Supply current (per channel)	No load, V_{OUT} = V_{CC}/2		295	345	µA
		Tmin < T < Tmax			420	
AC performance						
GBP	Gain bandwidth product	R_L = 10 kΩ, C_L = 100 pF	1.1	1.55		MHz
		Tmin < T < Tmax	0.8			
Φ_m	Phase margin	R_L = 10 kΩ, C_L = 100 pF		60		degrees
G_m	Gain margin			18		dB
SR	Slew rate	T = 25 °C	0.35	0.58		V/µs
		Tmin < T < Tmax	0.20			
E_N	Equivalent input noise voltage	f = 1 kHz		30		nV/√Hz
THD+N	Total harmonic distortion + noise	f_{in} = 1 kHz, Gain = 1, R_L = 100 kΩ, V_{icm} = (V_{CC} -1 V) / 2, BW = 22 kHz, V_{OUT} = 1 Vpp		0.005		%
C_S	Channel separation	f = 1 kHz		120		dB
t_{rec}	Overload recovery time			2		µs

Table 6. Electrical characteristics V_{CC+} = 36 V, V_{CC-} = 0 V, V_{icm} = V_{CC}/2, T = 25 °C, R_L = 10 kΩ connected to Vcc/2 (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
DC performance						
V_{IO}	Input offset voltage	T = 25 °C	-1		1	mV
		Tmin < T < Tmax	-1.6		1.6	
$\lvert\Delta V_{IO}/\Delta T\rvert$	Input offset voltage drift	Tmin < T < Tmax		2		µV/°C
I_{IB}	Input bias current	T = 25 °C		15	30	nA
		Tmin < T < Tmax			45	
I_{IO}	Input offset current	T = 25 °C		3	10	
		Tmin < T < Tmax			15	
CMR	Common mode rejection ratio: 20 log ($\Delta V_{icm}/\Delta V_{io}$)	V_{icm} = -0.1 to V_{CC} -1 V, V_{OUT} = V_{CC}/2	105	135		dB
		Tmin < T < Tmax	100			
SVR	Supply voltage rejection ratio: 20 log ($\Delta V_{CC}/\Delta V_{io}$)	V_{CC} = 4.5 to 36 V, V_{icm} = 0 V	100	124		dB
		Tmin < T < Tmax	95			
A_{VD}	Large signal voltage gain	V_{OUT} = 0.5 V to (V_{CC} -0.5 V)	105	120		dB
		Tmin < T < Tmax	100			
V_{OH}	High-level output voltage, V_{OH} = V_{CC} - V_{OUT}	T = 25 °C		110	140	mV
		Tmin < T < Tmax			180	
V_{OL}	Low-level output voltage	T = 25 °C		125	150	
		Tmin < T < Tmax			195	
I_{OUT}	I_{sink}	V_{OUT} = V_{CC}	35	45		mA
		Tmin < T < Tmax	15			
	I_{source}	V_{OUT} = 0 V	35	45		
		Tmin < T < Tmax	25			
I_{CC}	Supply current (per channel)	No load, V_{OUT} = V_{CC}/2		310	375	µA
		Tmin < T < Tmax			420	
AC performance						
GBP	Gain bandwidth product	R_L = 10 kΩ, C_L = 100 pF	1.2	1.7		MHz
		Tmin < T < Tmax	0.95			
Φ_m	Phase margin	R_L = 10 kΩ, C_L = 100 pF		58		degrees
G_m	Gain margin			18		dB
SR	Slew rate	T = 25 °C	0.35	0.60		V/µs
		Tmin < T < Tmax	0.25			
E_N	Equivalent input noise voltage	f = 1 kHz		25		nV/√Hz
THD+N	Total harmonic distortion + noise	f_{in} = 1 kHz, Gain = 1, R_L = 100 kΩ, V_{icm} = (V_{CC} - 1 V) / 2, BW = 22 kHz, V_{OUT} = 1 Vpp		0.005		%
C_S	Channel separation	f = 1 kHz		120		dB
t_{rec}	Overload recovery time			2		µs

4 Typical performance characteristics

Figure 2. Supply current vs. supply voltage

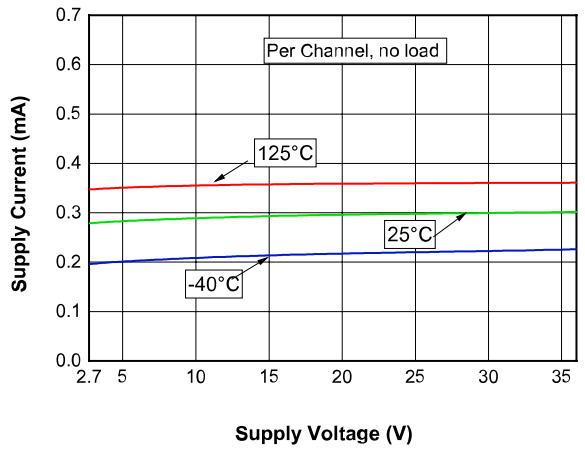


Figure 3. Input offset voltage distribution at V_{CC} = 2.7 V

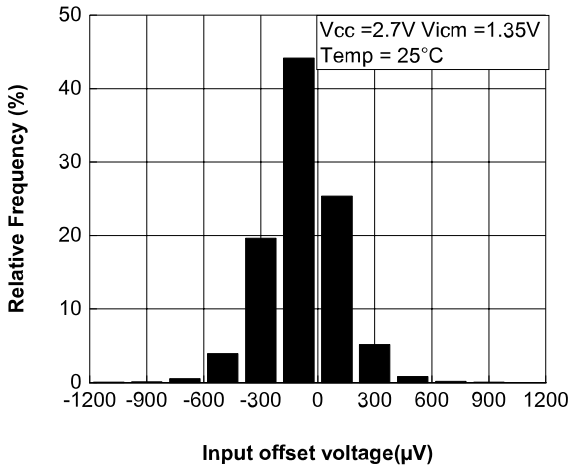


Figure 4. Input offset voltage distribution at V_{CC} = 12 V

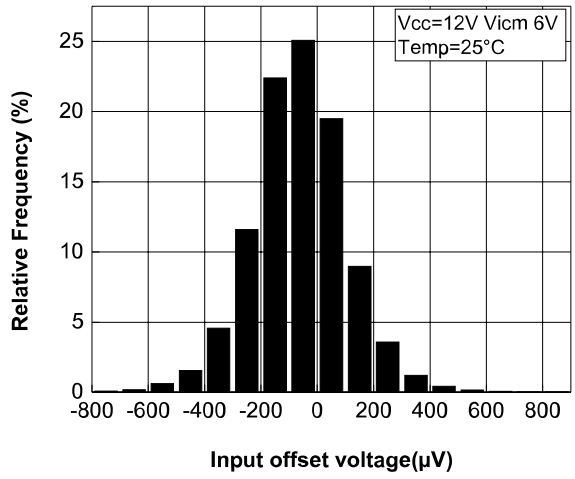


Figure 5. Input offset voltage distribution at V_{CC} = 36 V

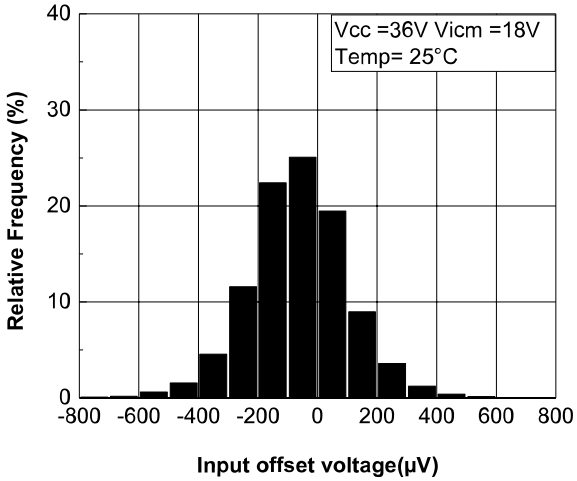


Figure 6. Input offset voltage vs. temperature at V_{CC} = 36 V

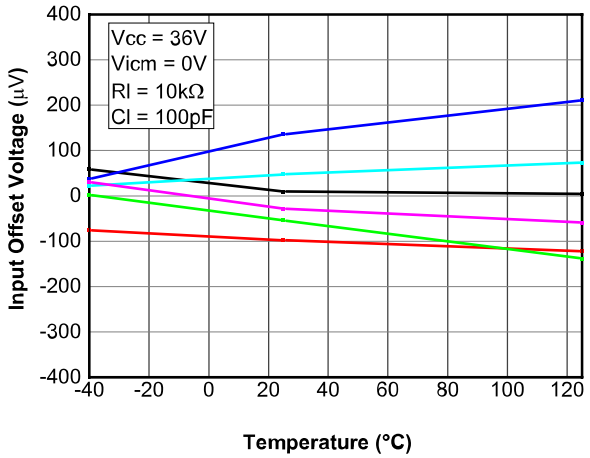


Figure 7. Input offset voltage temperature variation distribution at V_{CC} = 36 V

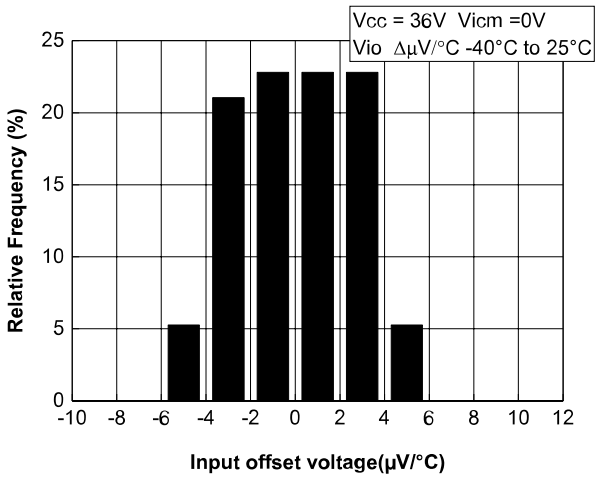


Figure 8. Input offset voltage temperature variation distribution at V_{CC} = 36 V

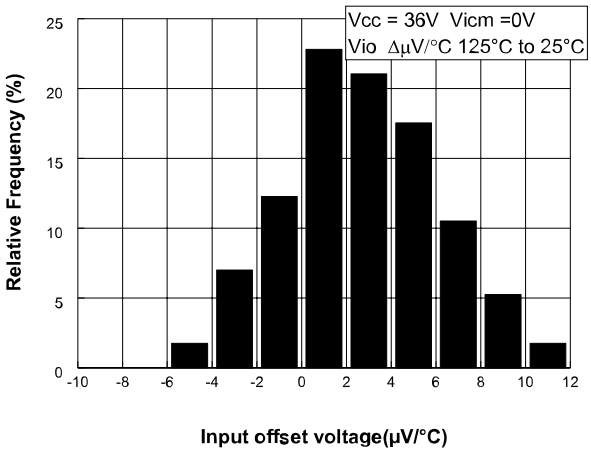


Figure 9. Input offset voltage vs. common-mode voltage at V_{CC} = 36 V

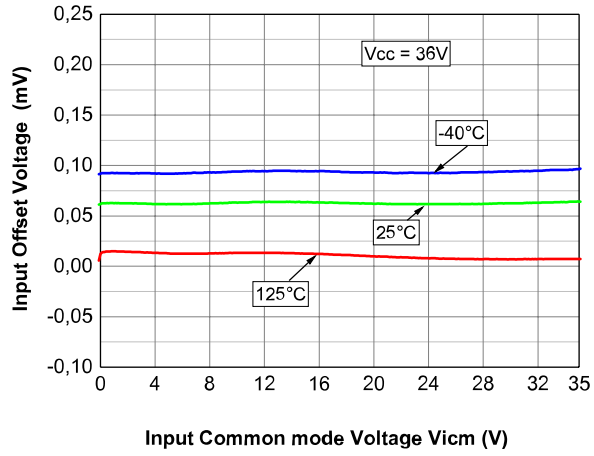


Figure 10. Common-mode reject. ratio CMR at V_{CC} = 5 V

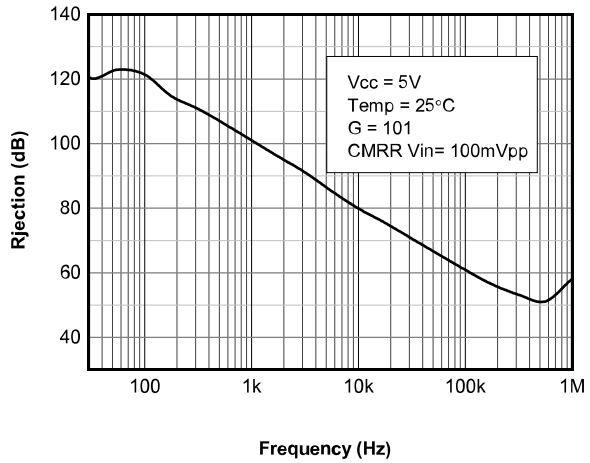


Figure 11. Supply voltage rejection ratio SVR at V_{CC} = 5 V

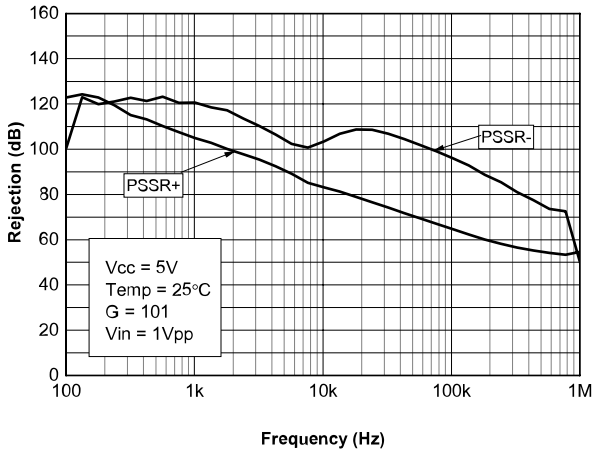


Figure 12. Input bias current vs. temperature

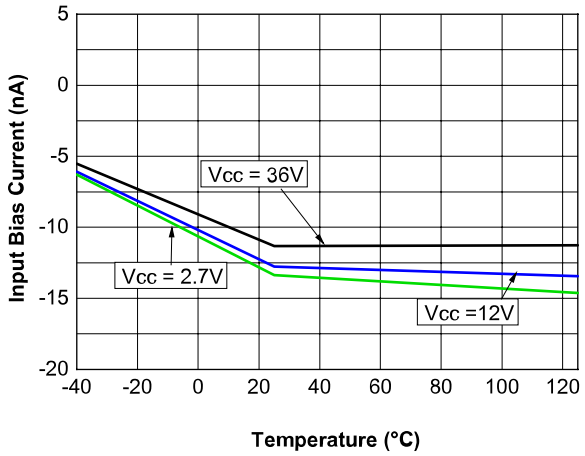


Figure 13. Bode diagram at V_{CC} = 2.7 V

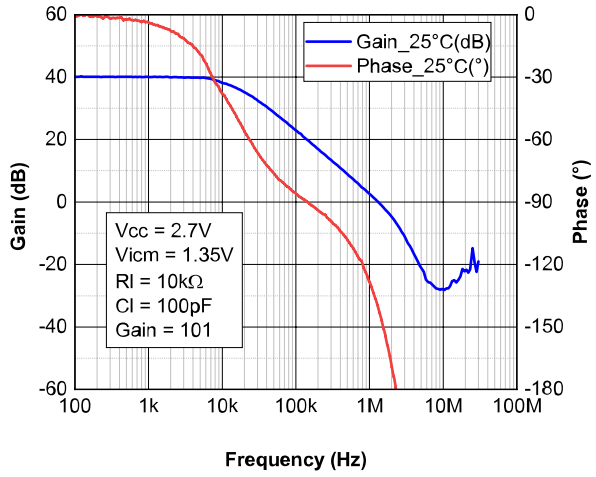


Figure 14. Bode diagram at V_{CC} = 12 V

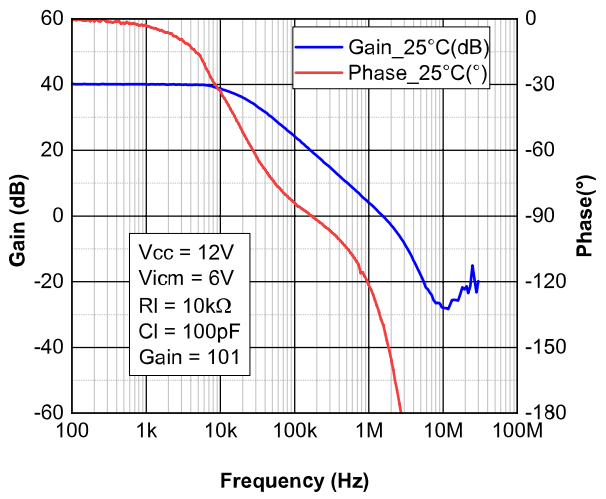


Figure 15. Bode diagram at V_{CC} = 36 V

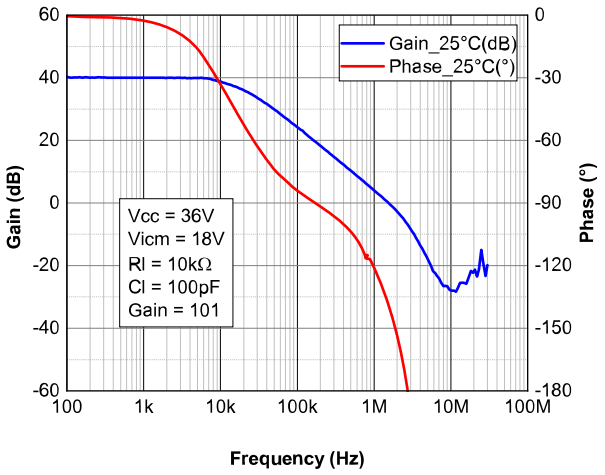


Figure 16. Overshoot vs. capacitive load at V_{CC} = 36 V

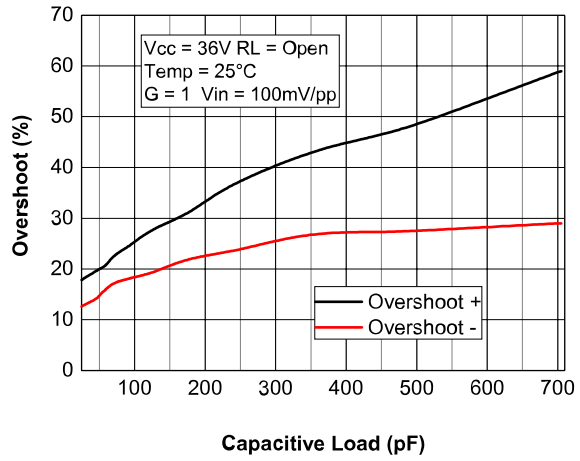


Figure 17. Phase margin vs. capacitive load at V_{CC} = 2.7 V

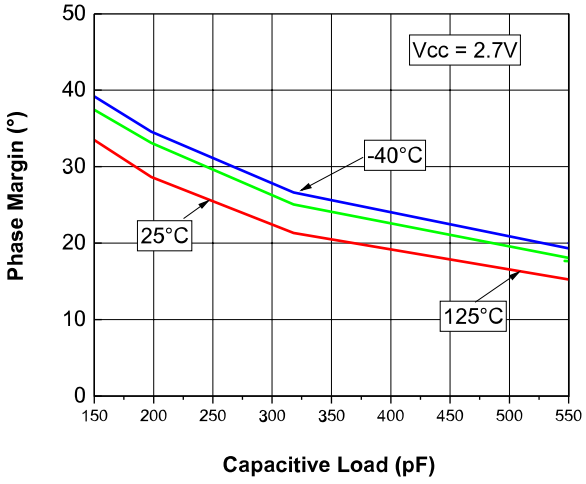


Figure 18. Phase margin vs. capacitive load at V_{CC} = 12 V

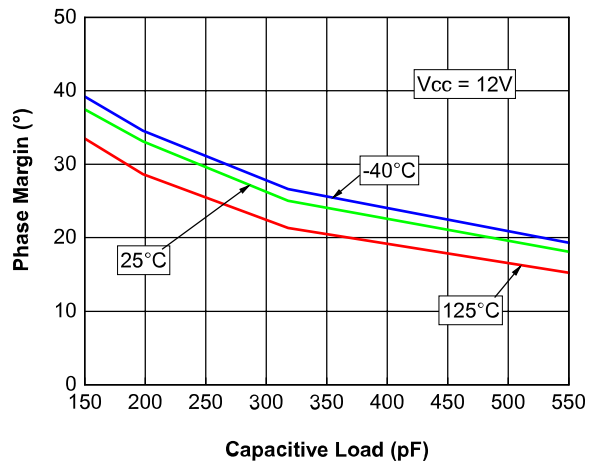


Figure 19. Phase margin vs. capacitive load at V_{CC} = 36 V

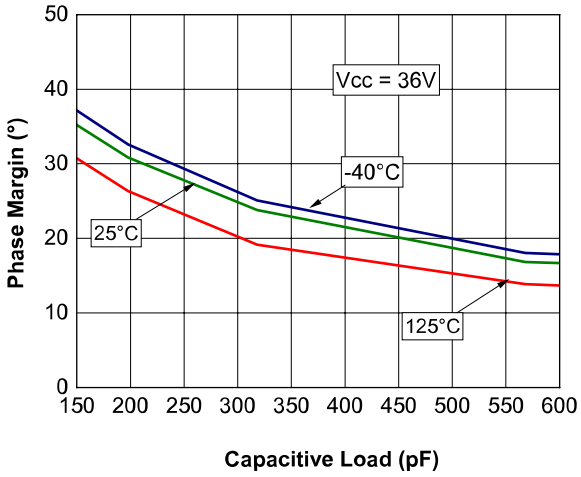


Figure 20. Short-circuit current vs. temperature

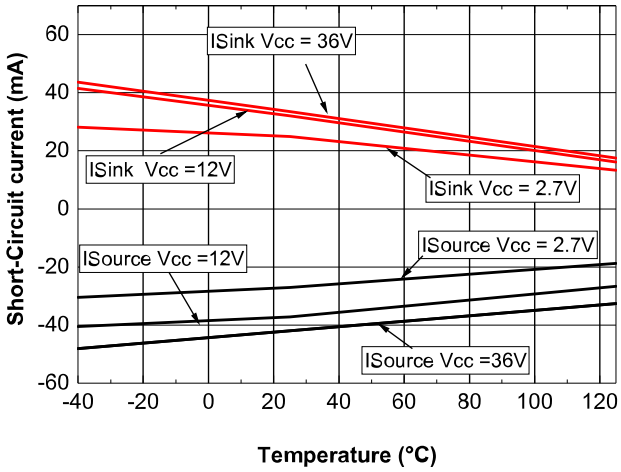


Figure 21. Output source current vs. output voltage at V_{CC} = 2.7 V

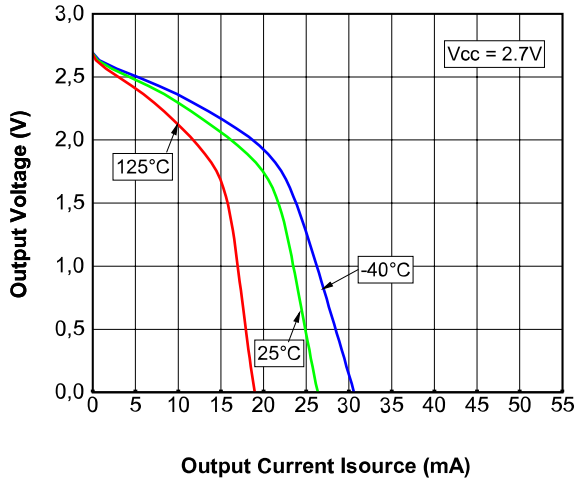


Figure 22. Output source current vs. output voltage at V_{CC} = 12 V

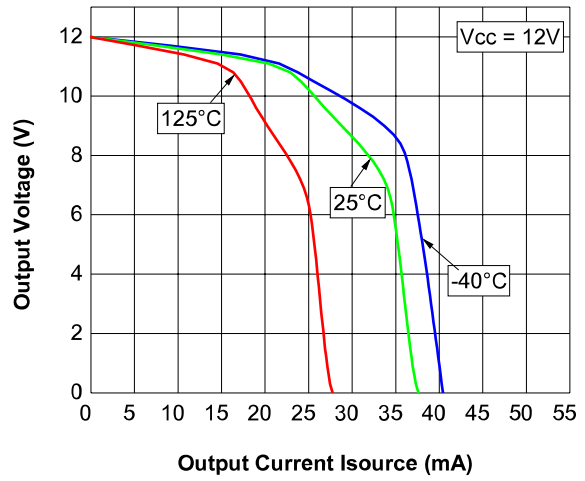


Figure 23. Output source current vs. output voltage at V_{CC} = 36 V

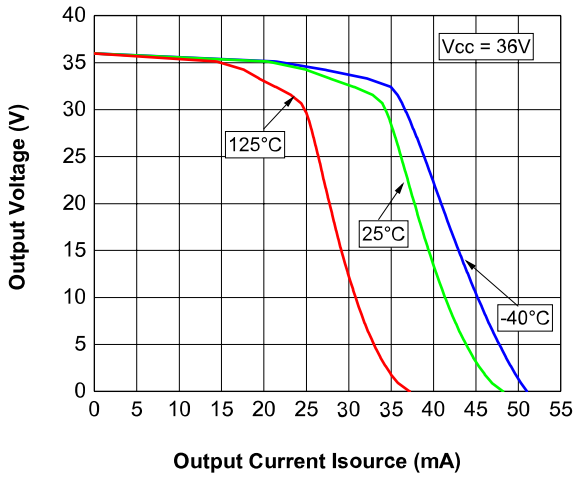


Figure 24. Output sink current vs. output voltage at V_{CC} = 2.7 V

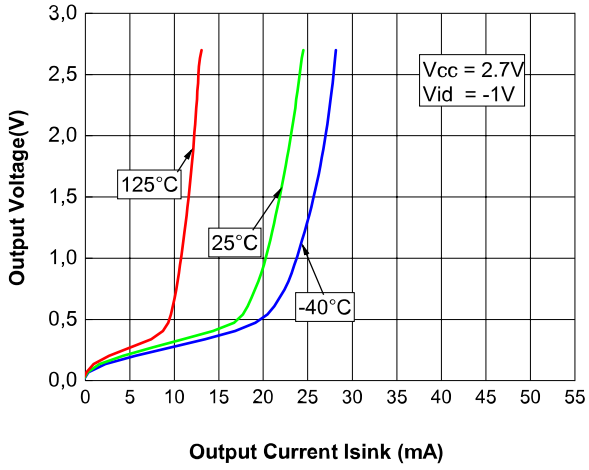


Figure 25. Output sink current vs. output voltage at V_{CC} = 12 V

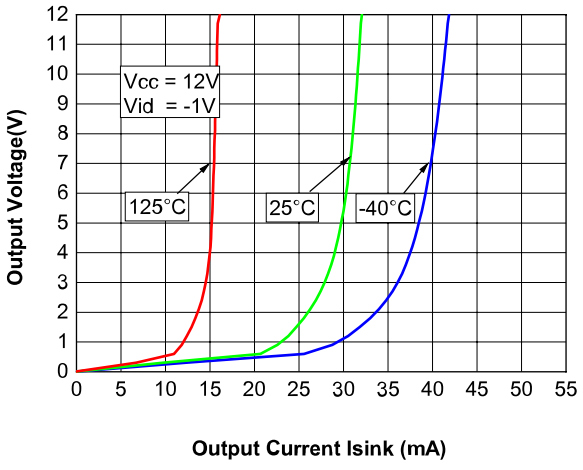


Figure 26. Output sink current vs. output voltage at V_{CC} = 36 V

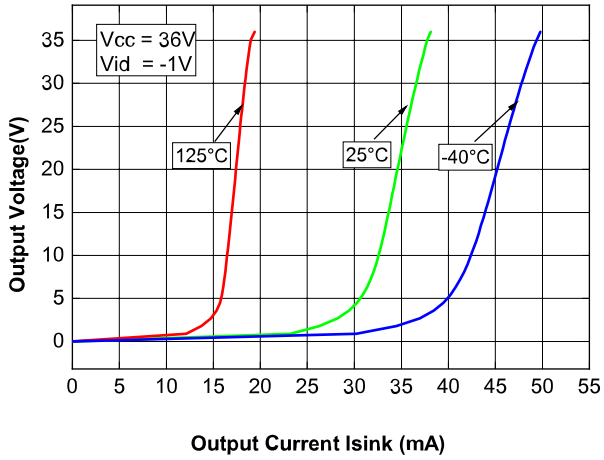


Figure 27. Slew rate at V_{CC} = 2.7 V

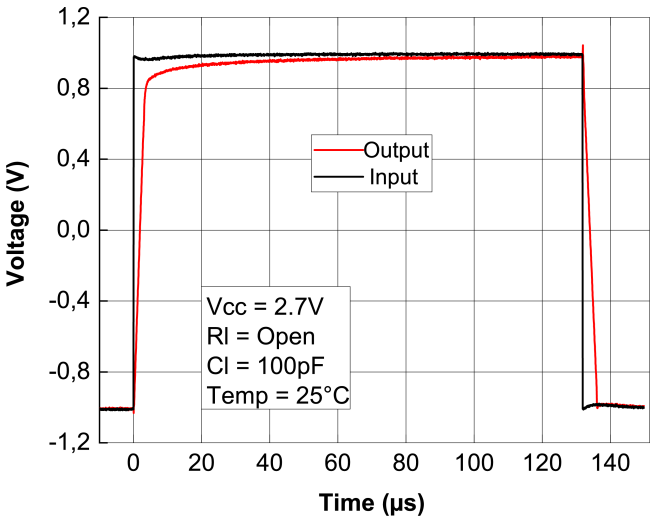


Figure 28. Slew rate at V_{CC} = 12 V

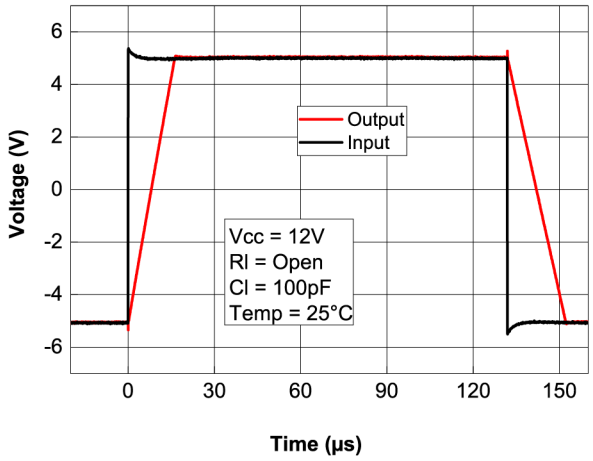


Figure 29. Slew rate at V_{CC} = 36 V

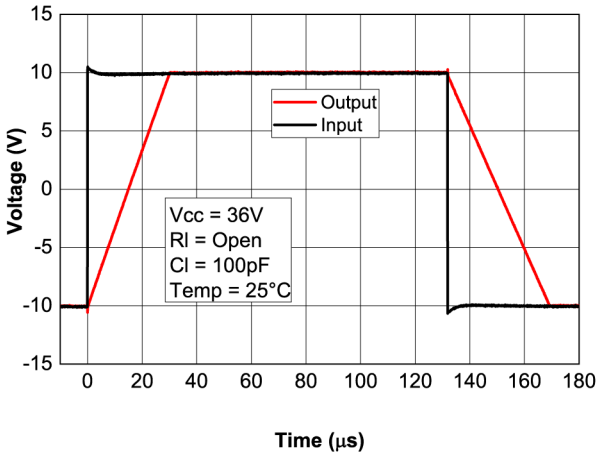


Figure 30. Slew rate vs. temperature at V_{CC} = 36 V

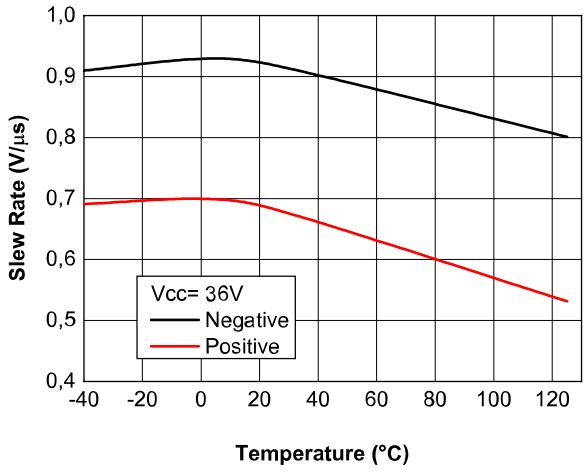


Figure 31. Small signal step response

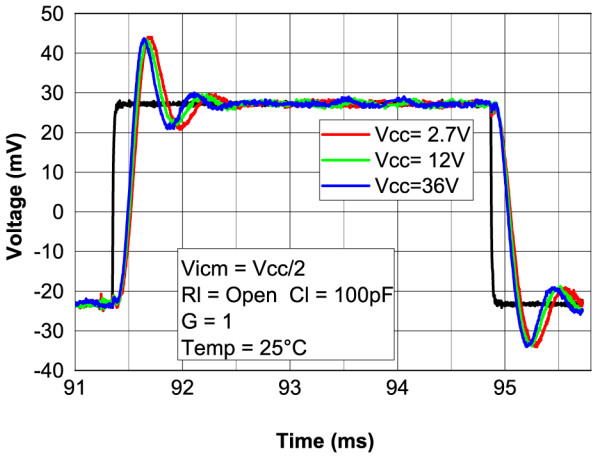


Figure 32. Maximum output voltage vs. frequency

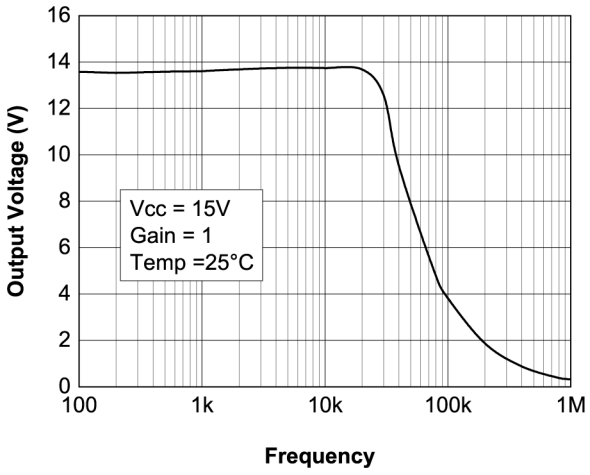


Figure 33. THD+Noise vs. frequency

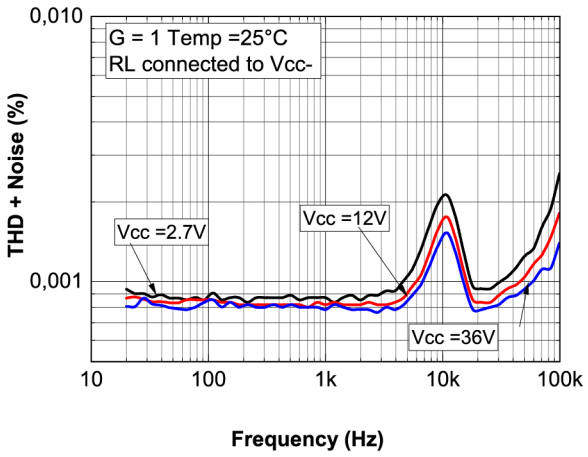


Figure 34. **THD+Noise vs. output voltage**

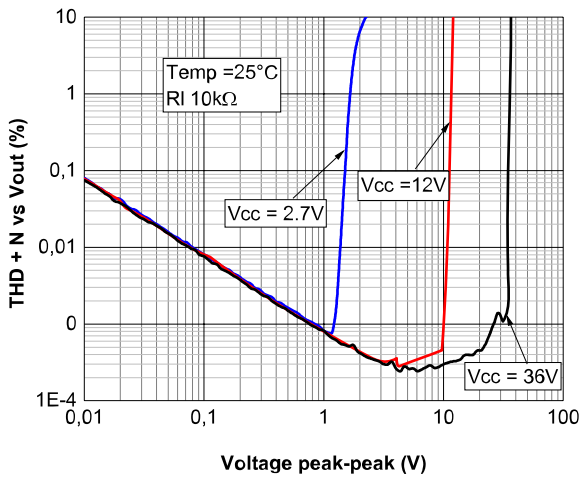


Figure 35. **Cross talk vs. frequency**

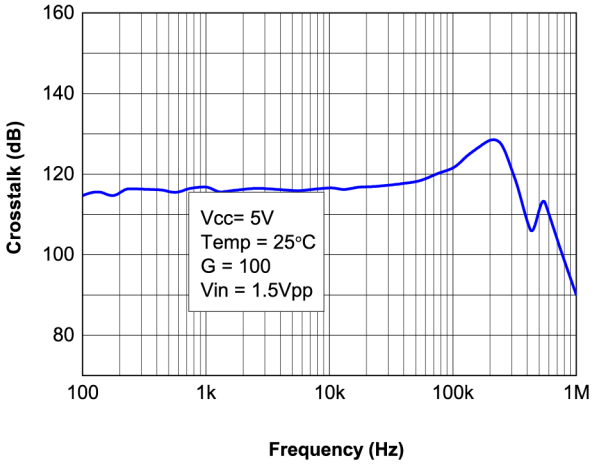
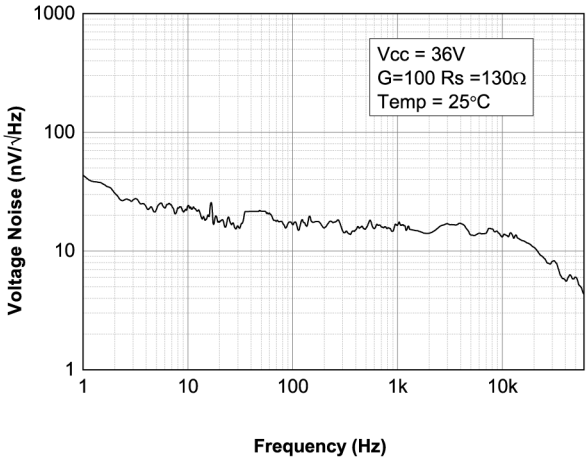


Figure 36. **Equivalent input noise voltage vs. frequency**



5 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

5.1 SO8 package information

Figure 37. **SO8 package outline**

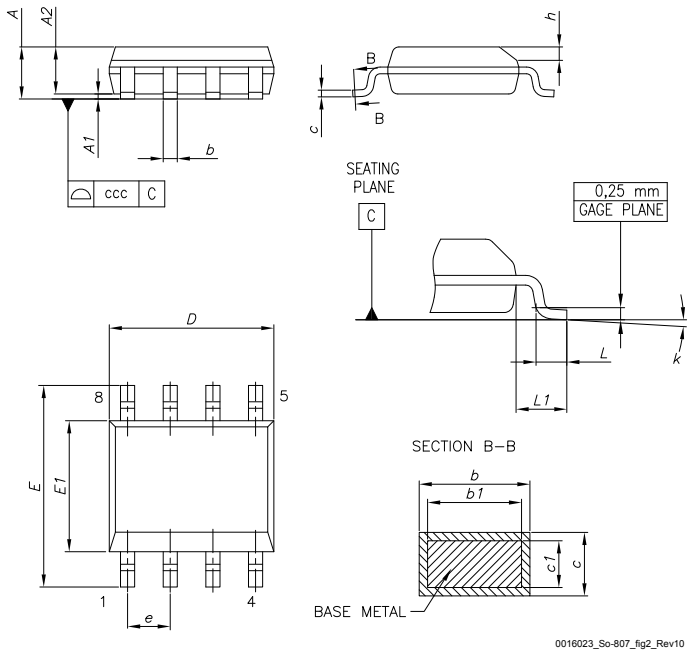


Table 7. **SO8 mechanical data**

Dim.	mm		
	Min.	Typ.	Max.
A			1.75
A1	0.10		0.25
A2	1.25		
b	0.31		0.51
b1	0.28		0.48
c	0.10		0.25
c1	0.10		0.23
D	4.80	4.90	5.00
E	5.80	6.00	6.20
E1	3.80	3.90	4.00
e		1.27	
h	0.25		0.50
L	0.40		1.27
L1		1.04	
L2		0.25	
k	0°		8°
ccc			0.10

5.2 MiniSO8 package information

Figure 38. **MiniSO8 package outline**

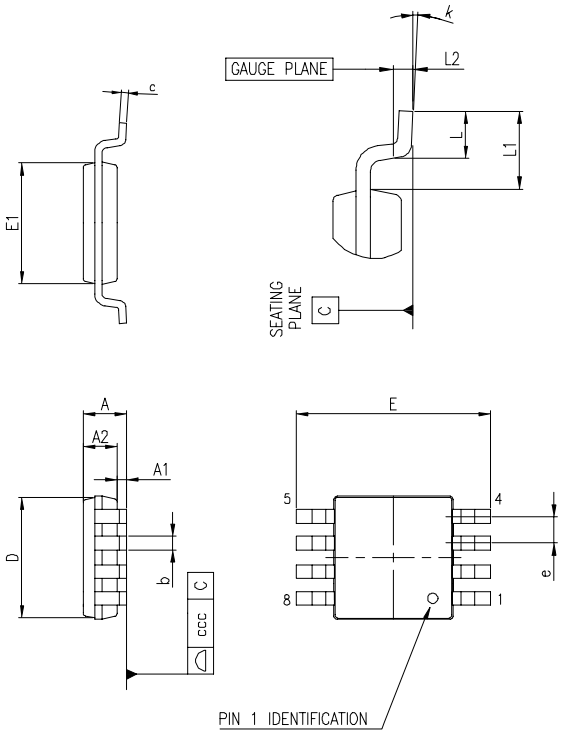


Table 8. **MiniSO8 mechanical data**

Dim.	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0		0.15	0		0.006
A2	0.75	0.85	0.95	0.03	0.033	0.037
b	0.22		0.4	0.009		0.016
c	0.08		0.23	0.003		0.009
D	2.8	3	3.2	0.11	0.118	0.126
E	4.65	4.9	5.15	0.183	0.193	0.203
E1	2.8	3	3.1	0.11	0.118	0.122
e		0.65			0.026	
L	0.4	0.6	0.8	0.016	0.024	0.031
L1		0.95			0.037	
L2		0.25			0.01	
k	0°		8°	0°		8°
ccc			0.1			0.004

5.3 DFN8 3x3 package information

Figure 39. **DFN8 3x3 package outline and mechanical data**

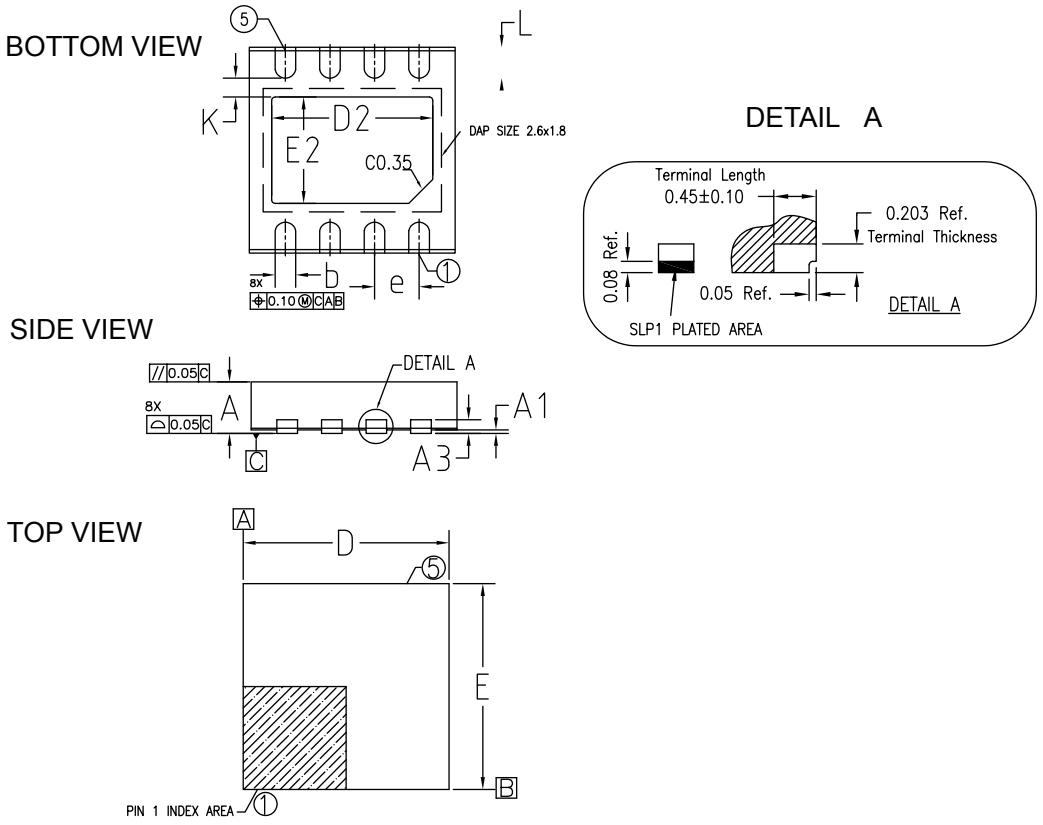
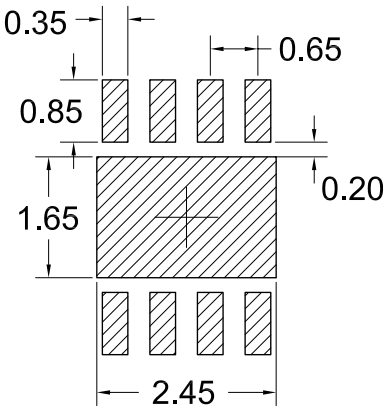


Table 9. **DFN8 3x3 mechanical data**

Symbol	mm		
	Min.	Typ.	Max.
A	0.70	0.75	0.80
A1	0.0		0.05
A3		0.20 Ref.	
b	0.25	0.30	0.35
D	2.95	3.00	3.05
D2	2.25	2.35	2.45
e		0.65 BSC	
E	2.95	3.00	3.05
E2	1.45	1.55	1.65
L	0.35	0.45	0.55
K		2.75 Ref.	
N		8	

Figure 40. **DFN8 3x3 footprint data**



6 Ordering information

Table 10. Order code

Order code	Package	Packaging	Marking
TSB622IDT	SO8	Tape & Reel	TSB622I
TSB622IYDT (1)			TSB622IY
TSB622IST	MiniSO8		K2K
TSB622IYST (1)			K2L
TSB622IQ3T	DFN8 3x3 WF		K2K
TSB622IYQ3T (1)			K2L

1. *Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q002 or equivalent.*

Revision history

Table 11. **Document revision history**

Date	Revision	Changes
03-Nov-2021	1	Initial release.
15-Feb-2022	2	Updated Figure 2.

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